

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	20067	(eject\$6 or jet\$6 or jetdispens\$6) near20 (polymer or stress\$6 or encapsul\$6 or underfill\$6 or buffer\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/12/28 11:55
L2	2880	1 and (bump or solder\$6 or ball)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/12/28 11:56
L3	2528	2 and (@ad<"20040331" or @riad<"20040331")	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/12/28 11:57
L4	1732	3 and (substrate or wafer or die or dice or chip or semiconductor)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/12/28 11:57